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NC7SVL04 TinyLogic® Low-I_{CC}T Inverter

Features

- 0.9V to 3.6V V_{CC} Supply Operation
- 3.6V Over-Voltage Tolerant I/Os at V_{CC} from 0.9V to 3.6V
- Power-Off High Impedance Inputs and Outputs
- Proprietary Quiet Series™ Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak™ Package
- Ultra-Low Dynamic Power

Description

The NC7SVL04 is a single inverter with a low-I_{CC}T input design from Fairchild's Ultra-Low Power (ULP-A) series of TinyLogic®. The NC7SVL04 features very low quiescent current, even when the input voltage is lower than the V_{CC} supply. This feature services mobile handset applications very well, allowing for direct interface with baseband processor general-purpose I/Os. Since mobile devices rely on a battery supply, the NC7SVL04 facilitates lower power consumption in mixed-voltage rail environments.

This product is designed on an advanced CMOS technology for a wide low-voltage operating range (0.9V to 3.6V V_{CC}), high drive needs (up to 24mA), and speed (maximum propagation delay of 3.5ns, V_{CC}=3.3V). It achieves this performance while maintaining low CMOS power dissipation.

Ordering Information

| Part Number | Top Mark | Package | Packing Method |
|-------------|----------|---|---------------------------|
| NC7SVL04P5X | L04 | 5-Lead SC70, EIAJ SC-88a, 1.25mm Wide | 3000 Units on Tape & Reel |
| NC7SVL04L6X | CD | 6-Lead MicroPak™, 1.00mm Wide | 5000 Units on Tape & Reel |
| NC7SVL04FHX | CD | 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch | 5000 Units on Tape & Reel |

Connection Diagram



Figure 1. Logic Symbol

Pin Configurations

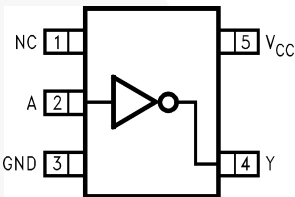


Figure 2. SC70 (Top View)

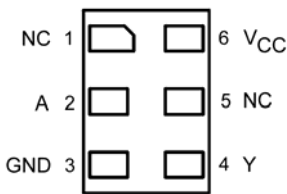


Figure 3. MicroPak™ (Top Through View)

Pin Definitions

| Pin # SC70 | Pin # MicroPak™ | Name | Description |
|------------|-----------------|-----------------|----------------|
| 1 | 1 | NC | No Connect |
| 2 | 2 | A | Input |
| 3 | 3 | GND | Ground |
| 4 | 4 | Y | Output |
| 5 | 6 | V _{CC} | Supply Voltage |
| | 5 | NC | No Connect |

Function Table

Y=A

| Inputs | Output |
|--------|--------|
| A | Y |
| L | H |
| H | L |

H = HIGH Logic Level

L = LOW Logic Level

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Min. | Max. | Unit |
|-------------------------------------|---|------------------------------------|-----------------------|------|
| V _{CC} | Supply Voltage | -0.5 | 4.6 | V |
| V _{IN} | DC Input Voltage | -0.5 | 4.6 | V |
| V _{OUT} | DC Output Voltage | HIGH or LOW State ⁽¹⁾ | V _{CC} + 0.5 | V |
| | | V _{CC} =0V | 4.6 | |
| I _{IK} | DC Input Diode Current | V _{IN} < 0V | -50 | mA |
| I _{OK} | DC Output Diode Current | V _{OUT} < 0V | -50 | mA |
| | | V _{OUT} > V _{CC} | +50 | |
| I _{OH} / I _{OL} | DC Output Source/Sink Current | | ±50 | mA |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current per Supply Pin | | ±50 | mA |
| T _{STG} | Storage Temperature Range | -65 | +150 | °C |
| T _J | Junction Temperature Under Bias | | +150 | °C |
| T _L | Junction Lead Temperature, Soldering 10 Seconds | | +260 | °C |
| P _D | Power Dissipation at +85°C | SC70-5 | 150 | mW |
| | | MicroPak™-6 | 130 | |
| | | MicroPak2™-6 | 120 | |
| ESD | Human Body Model, JEDEC:JESD22-A114 | | 4000 | V |
| | Charge Device Model, JEDEC:JESD22-C101 | | 2000 | |

Note:

1. I_O absolute maximum ratings must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Conditions | Min. | Max. | Unit |
|----------------------------------|--|--|------|-----------------|------|
| V _{CC} | Supply Voltage | | 0.9 | 3.6 | V |
| V _{IN} | Input Voltage | | 0 | 3.6 | V |
| V _{OUT} | Output Voltage | V _{CC} =0V | 0 | 3.6 | V |
| | | HIGH or LOW State | 0 | V _{CC} | |
| I _{OH} /I _{OL} | Output Current in I _{OH} /I _{OL} | V _{CC} =3.0V to 3.6V | | ±24.0 | mA |
| | | V _{CC} =2.3V to 2.7V | | ±18.0 | |
| | | V _{CC} =1.65V to 1.95V | | ±6.0 | |
| | | V _{CC} =1.4V to 1.6V | | ±4.0 | |
| | | V _{CC} =1.1V to 1.3V | | ±2.0 | |
| | | V _{CC} =0.9V | | ±0.1 | |
| T _A | Operating Temperature, Free Air | | -40 | +85 | °C |
| Δt/ΔV | Minimum Input Edge Rate | V _{IN} =0.8V to 2.0V, V _{CC} =3.0V | | 10 | ns/V |
| θ _{JA} | Thermal Resistance | SC70-5 | | 425 | °C/W |
| | | MicroPak™-6 | | 500 | |
| | | MicroPak2™-6 | | 560 | |

Note:

2. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| Symbol | Parameter | V _{CC} | Conditions | T _A =25°C | | T _A =-40 to +85°C | | Units |
|-----------------|---------------------------|-------------------------------|-------------------------|-----------------------|-----------------------|------------------------------|-----------------------|-------|
| | | | | Min. | Max. | Min. | Max. | |
| V _{IH} | HIGH Level Input Voltage | 0.90 | | .65 x V _{CC} | | .65 x V _{CC} | | V |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | | .65 x V _{CC} | | .65 x V _{CC} | | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | | .65 x V _{CC} | | .65 x V _{CC} | | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | | 0.90 | | .0.90 | | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | | 1.50 | | 1.50 | | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | 1.50 | | 1.50 | | |
| V _{IL} | LOW Level Input Voltage | 0.90 | | | .25 x V _{CC} | | .25 x V _{CC} | V |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | | | .25 x V _{CC} | | .25 x V _{CC} | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | | | .25 x V _{CC} | | .25 x V _{CC} | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | | | .25 x V _{CC} | | .25 x V _{CC} | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | | | 0.70 | | 0.70 | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | | 0.80 | | 0.80 | |
| V _{OH} | HIGH Level Output Voltage | 0.90 | I _{OH} =-100μA | V _{CC} -0.10 | | V _{CC} -0.10 | | V |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | | V _{CC} -0.10 | | V _{CC} -0.10 | | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | | V _{CC} -0.20 | | V _{CC} -0.20 | | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | | V _{CC} -0.20 | | V _{CC} -0.20 | | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | | V _{CC} -0.20 | | V _{CC} -0.20 | | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | V _{CC} -0.20 | | V _{CC} -0.20 | | |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | I _{OH} =-2mA | .75 x V _{CC} | | .75 x V _{CC} | | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | I _{OH} =-4mA | .75 x V _{CC} | | .75 x V _{CC} | | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | I _{OH} =-6mA | 1.25 | | 1.25 | | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | | 2.00 | | 2.00 | | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | I _{OH} =-12mA | 1.80 | | 1.80 | | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | 2.20 | | 2.20 | | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | I _{OH} =-18mA | 1.70 | | 1.70 | | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | 2.40 | | 2.40 | | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | I _{OH} =-24mA | 2.20 | | 2.20 | | |

Continued on the following page...

DC Electrical Characteristics (Continued)

| Symbol | Parameter | V _{CC} | Conditions | T _A =25°C | | T _A =-40 to 85°C | | Units |
|-------------------|---------------------------------------|-------------------------------|---|----------------------|------------------------|-----------------------------|------------------------|-------|
| | | | | Min. | Max. | Min. | Max. | |
| V _{OL} | LOW Level Output Voltage | 0.90 | I _{OL} =100μA | | 0.10 | | 0.10 | V |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | | | 0.10 | | 0.10 | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | | | 0.20 | | 0.20 | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | | | 0.20 | | 0.20 | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | | | 0.20 | | 0.20 | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | | 0.20 | | 0.20 | |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | I _{OL} =2mA | | 0.25 x V _{CC} | | 0.25 x V _{CC} | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | I _{OL} =4mA | | 0.25 x V _{CC} | | 0.25 x V _{CC} | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | I _{OL} =6mA | | 0.30 | | 0.30 | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | I _{OL} =12mA | | 0.40 | | 0.40 | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | | 0.40 | | 0.40 | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | I _{OL} =18mA | | 0.60 | | 0.60 | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | | 0.40 | | 0.40 | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | I _{OL} =24mA | | 0.55 | | 0.55 | |
| I _{IN} | Input Leakage Current | 0.90 to 3.60 | 0 ≤ V _{IN} ≤ 3.60V | | ±0.1 | | ±0.5 | μA |
| I _{OFF} | Power Off Leakage Current | 0 | 0 ≤ (V _{IN} , V _O) ≤ 3.60V | | 0.5 | | 0.5 | μA |
| I _{CC} | Quiescent Supply Current | 0.90 to 3.60 | V _{IN} =V _{CC} or GND | | 0.9 | | 0.9 | μA |
| | | | V _{CC} ≤ V _{IN} ≤ 3.60V | | | | ±0.9 | |
| I _{CC} T | Increase in I _{CC} per Input | 1.95 | V _{IN} =0.9V | | 6 | | 8 | μA |
| | | 3.60 | V _{IN} =1.5V | | 6 | | 8 | |

AC Electrical Characteristics

| Symbol | Parameter | V _{CC} | Conditions | T _A =25°C | | | T _A =-40 to 85°C | | Units | Figure |
|-------------------------------------|-------------------------------|-------------------------------|--|----------------------|------|------|-----------------------------|------|-------|----------------------|
| | | | | Min. | Typ. | Max. | Min. | Max. | | |
| t _{PHL} , t _{PLH} | Propagation Delay | 0.90 | C _L =15pF, R _L =1MΩ | | 34.0 | | | | ns | Figure 4 Figure 5 |
| | | 1.10 ≤ V _{CC} ≤ 1.30 | C _L =15pF, R _L =2kΩ | 3.5 | 8.1 | 16.5 | 3.0 | 27.8 | | |
| | | 1.40 ≤ V _{CC} ≤ 1.60 | | 1.5 | 3.7 | 7.0 | 1.5 | 7.5 | | |
| | | 1.65 ≤ V _{CC} ≤ 1.95 | C _L =30pF, R _L =500Ω | 1.1 | 2.8 | 5.8 | 1.0 | 6.3 | | |
| | | 2.30 ≤ V _{CC} ≤ 2.70 | | 0.6 | 2.0 | 4.0 | 0.6 | 4.5 | | |
| | | 2.70 ≤ V _{CC} ≤ 3.60 | | 0.5 | 1.5 | 3.5 | 0.5 | 4.0 | | |
| C _{IN} | Input Capacitance | 0 | | | 3 | | | | pF | |
| C _{PD} | Power Dissipation Capacitance | 0.90 to 3.60 | V _{IN} =0V or V _{CC} , f=10MHz | | 5 | | | | pF | |

AC Loadings and Waveforms

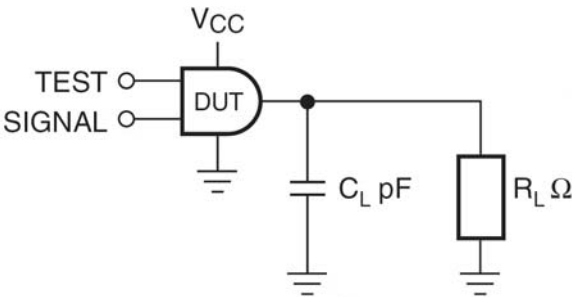


Figure 4. AC Test Circuit

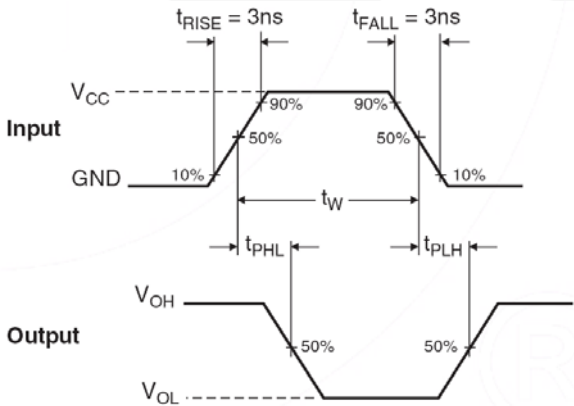


Figure 5. AC Waveforms

| Symbol | V _{CC} | | | | | |
|-----------------|-----------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| | 3.3V ± 0.3V | 2.5V ± 0.2V | 1.8V ± 0.15V | 1.5V ± 0.1V | 1.2V ± 0.1V | 0.9V |
| V _{mi} | 1.5V | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 |
| V _{mo} | 1.5V | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 | V _{CC} /2 |

Physical Dimensions

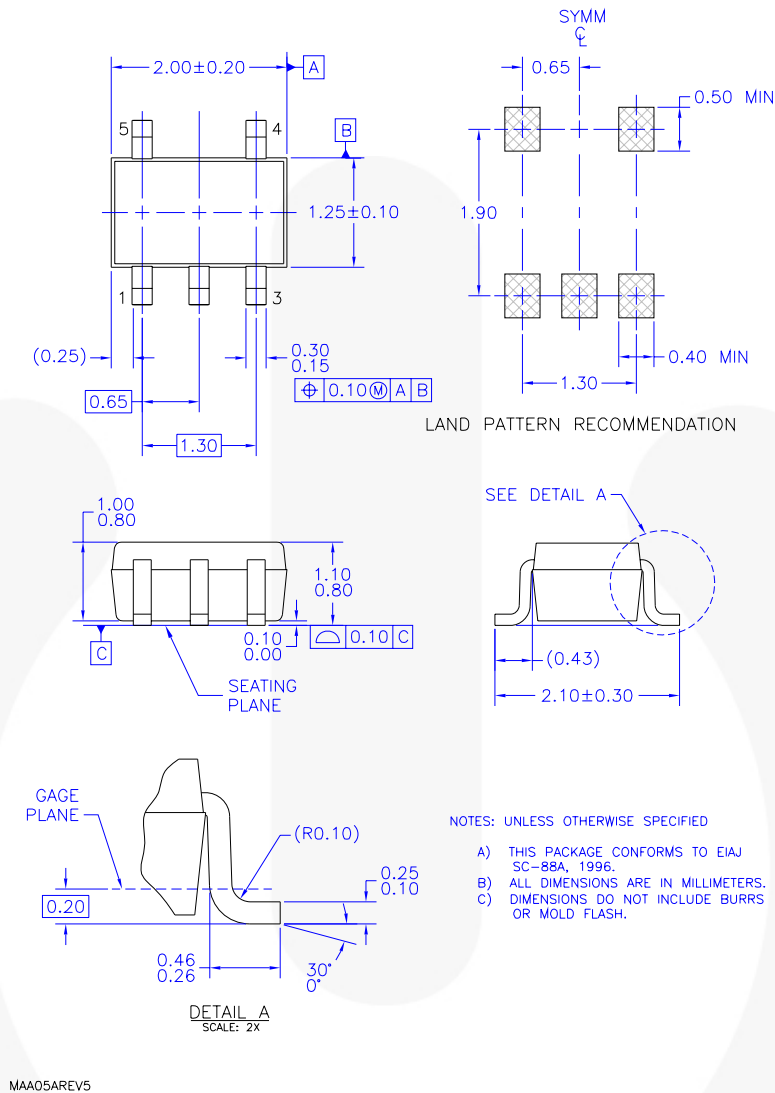


Figure 6. 5-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

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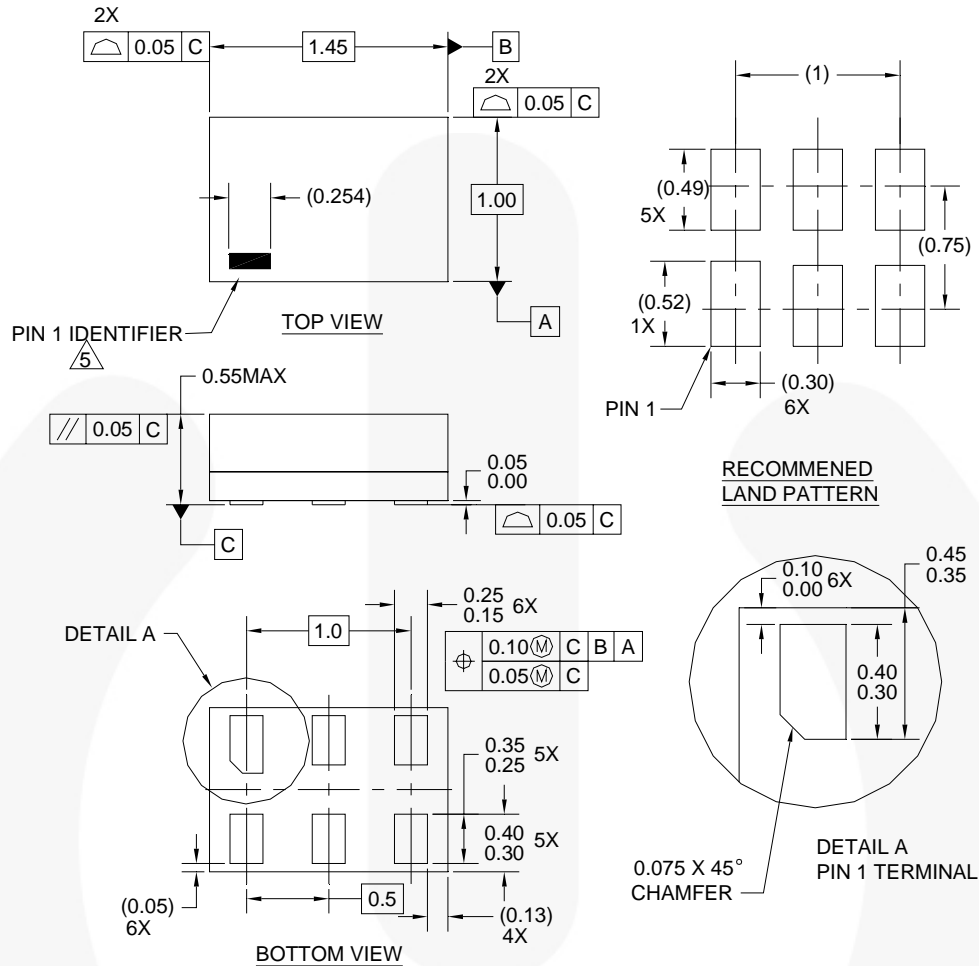
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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/analog/pdf/sc70-5_tr.pdf

| Package Designator | Tape Section | Cavity Number | Cavity Status | Cover Type Status |
|--------------------|--------------------|---------------|---------------|-------------------|
| P5X | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| | Carrier | 3000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |

Physical Dimensions



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994
4. FILENAME AND REVISION: MAC06AREV4
5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

Figure 7. 6-Lead, MicroPak™, 1.0mm Wide

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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf

| Package Designator | Tape Section | Cavity Number | Cavity Status | Cover Type Status |
|--------------------|--------------------|---------------|---------------|-------------------|
| L6X | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| | Carrier | 5000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |

Physical Dimensions

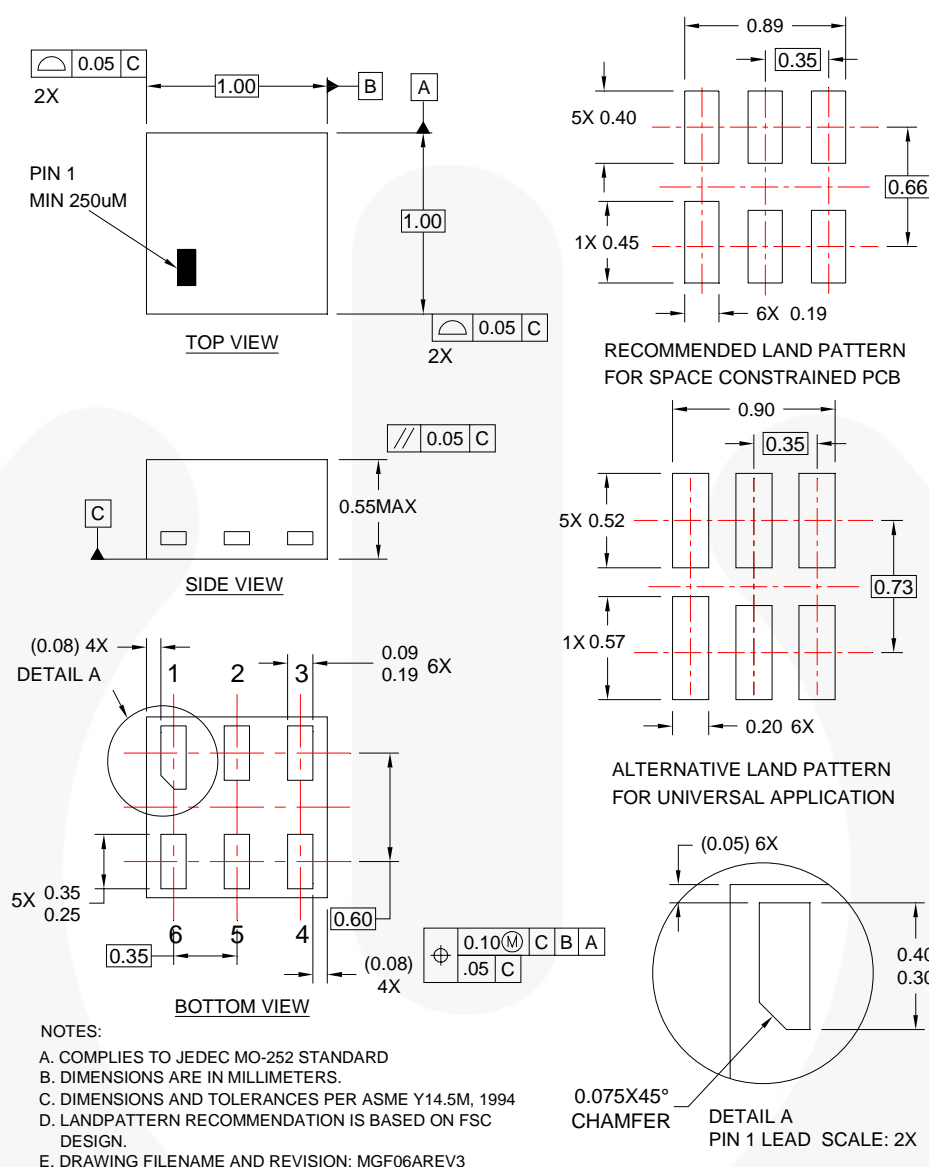


Figure 8. 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch

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Tape and Reel Specifications





Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/packaging/MicroPAK2_6L_tr.pdf.

| Package Designator | Tape Section | Cavity Number | Cavity Status | Cover Type Status |
|--------------------|--------------------|---------------|---------------|-------------------|
| FHX | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| | Carrier | 5000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |



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| ESBC™ | MicroPak™ | STEALTH™ | TRUECURRENT™* |
| F ® | MicroPak2™ | SuperFET® | µSerDes™ |
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| FAST® | OPTOLOGIC® | SyncFET™ | VCX™ |
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| FPS™ | | | |

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| Datasheet Identification | Product Status | Definition |
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Rev. I51

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